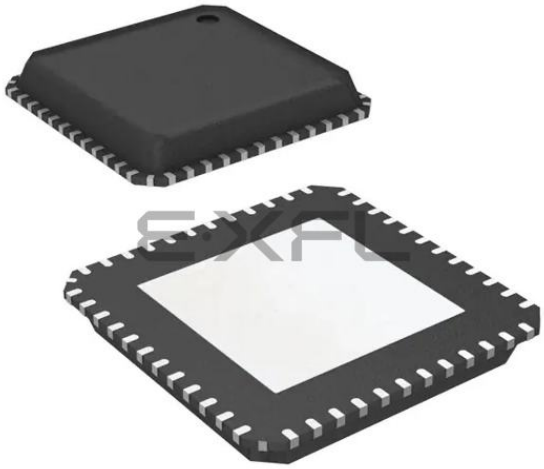
Infineon Technologies - XMC1401Q048F0128AAXUMA1 Datasheet



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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	ARM® Cortex®-M0
Core Size	32-Bit Single-Core
Speed	48MHz
Connectivity	I²C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, I²S, POR, PWM, WDT
Number of I/O	34
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	16K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 12x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	48-VFQFN Exposed Pad
Supplier Device Package	PG-VQFN-48-73
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/xmc1401q048f0128aaxuma1

About this Document

This Data Sheet is addressed to embedded hardware and software developers. It provides the reader with detailed descriptions about the ordering designations, available features, electrical and physical characteristics of the XMC1400 series devices.

The document describes the characteristics of a superset of the XMC1400 series devices. For simplicity, the various device types are referred to by the collective term XMC1400 throughout this document.

XMC1000 Family User Documentation

The set of user documentation includes:

- **Reference Manual**
  – decribes the functionality of the superset of devices.
- **Data Sheets**
  – list the complete ordering designations, available features and electrical characteristics of derivative devices.
- **Errata Sheets**
  – list deviations from the specifications given in the related Reference Manual or Data Sheets. Errata Sheets are provided for the superset of devices.

Attention: Please consult all parts of the documentation set to attain consolidated knowledge about your device.

Application related guidance is provided by **Users Guides** and **Application Notes**.

Please refer to **http://www.infineon.com/xmc1000** to get access to the latest versions of those documents.

1 Summary of Features

The XMC1400 devices are members of the XMC1000 Family of microcontrollers based on the ARM Cortex-M0 processor core. The XMC1400 series addresses the real-time control needs of motor control and digital power conversion. It also features peripherals for LED Lighting applications and Human-Machine Interface (HMI).

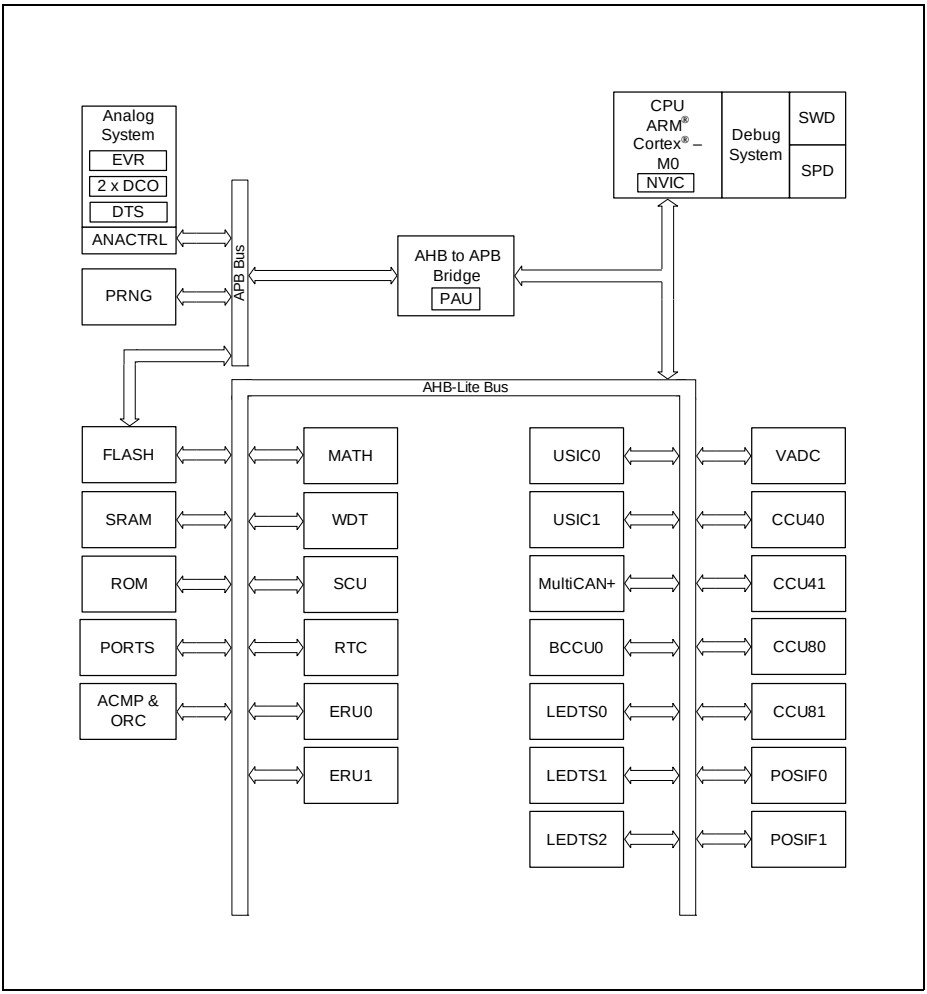

Figure 1 Block Diagram

Features

CPU subsystem

- 32-bit ARM Cortex-M0 CPU Core
  - 0.84 DMIPS/MHz (Dhrystone 2.1) at 48 MHz
- Nested Vectored Interrupt Controller
- 64 interrupt nodes
- MATH coprocessor
  - 24-bit trigonometric calculation (CORDIC)
  - 32-bit divide operation
- 2x4 channels ERU for event interconnections

On-Chip Memories

- 8 Kbyte ROM
- 16 Kbyte SRAM (with parity)
- up to 200 Kbyte Flash (with ECC)

Supply, Reset and Clock

- 1.8 V to 5.5 V supply with power on reset and brownout detector
- On-chip clock monitor
- External crystal oscillator support (32 kHz and 4 to 20 MHz)
- Internal slow and fast oscillators without the need of PLL

System Control

- Window watchdog
- Real time clock module
- Pseudo random number generator

Communication Peripherals

- Four USIC channels, usable as
  - UART (up to 12 Mb/s)
  - single-SPI (up to 12 Mb/s)
  - double-SPI (up to 2 × 12 Mb/s)
  - quad-SPI (up to 4 × 12 Mb/s)
  - IIC (up to 400 kb/s)
  - IIS (up to 12 Mb/s)
  - LIN interfaces (20kb/s)
- LEDTS in Human-Machine interface
  - up to 24 touch pads
  - drive up to 144 LEDs
- MultiCAN+, Full-CAN/Basic-CAN with 2 nodes, 32 message objects (up to 1 MBaud)

Analog Frontend Peripherals

- A/D Converters (up to 12 analog inputs)
  - 2 sample and hold stages
  - fast 12-bit ADC (up to 1.1 MS/s), adjustable gain
  - 0 V to 5.5 V input range
- Up to 8 channels out of range comparators
- Up to 4 fast analog comparators
- Temperature Sensor

Industrial Control Peripherals

- 2x4 16-bit 96 MHz CCU4 timers for signal monitoring and PWM
- 2x4 16-bit 96 MHz CCU8 timers for complex PWM, complementary high/low side switches and multi phase control
- 2x POSIF for hall and quadrature encoders, motor positioning
- 9 channel BCCU (brightness and color control) for LED lighting applications

Up to 56 Input/Output Ports

- 1.8 V to 5.5 V capable
- up to 8 high current pads (50 mA sink)

On-Chip Debug Support

- 4 breakpoints, 2 watchpoints
- ARM serial wire debug, single-pin debug interfaces

Programming Support

- Single-pin bootloader
- Secure bootstrap loader SBSL (optional)

Packages

- TSSOP-38 (9.7 × 6.4 mm^2)
- VQFN-40/48/64 (5×5/7×7/8×8 mm^2)
- LQFP-64 (12 × 12 mm^2)

Tools

- Free DAVE™ toolchain with low level drivers and apps

1.1 Device Overview

The following table lists the available features per device type for the XMC1400 series.

Table 1 Features of XMC1400 Device Types[1)]

Features		XMC1401-Q048	XMC1401-F064	XMC1402-T038	XMC1402-Q040	XMC1402-Q048	XMC1402-Q064	XMC1402-F064	XMC1403-Q040	XMC1403-Q048	XMC1403-Q064	XMC1404-Q048	XMC1404-Q064	XMC1404-F064
CPU frequency		48 MHz												
Operating temperature (ambient)		-40 to 85 °C		-40 to 105 °C										
Operating voltage		1.8 V to 5.5 V												
Flash options (Kbytes)		64, 128	64, 128	32, 64, 128 200	32, 64, 128 200	32, 64, 128 200	64, 128 200	64, 128 200	64, 128 200	64, 128 200	64, 128 200	64, 128 200	64, 128 200	64, 128 200
SRAM (Kbytes)		16	16	16	16	16	16	16	16	16	16	16	16	16
MATH		-	-	1	1	1	1	1	-	-	-	1	1	1
Industrial Control	CCU4	2	2	2	2	2	2	2	2	2	2	2	2	2
	CCU8	-	-	2	2	2	2	2	-	-	-	2	2	2
	POSIF	-	-	1	1	2	2	2	-	-	-	2	2	2
	BCCU	-	-	1	1	1	1	1	-	-	-	1	1	1
Communication	USIC (modules / channels)	2 / 2	2 / 2	2 / 2	2 / 2	2 / 2	2 / 2	2 / 2	2 / 2	2 / 2	2 / 2	2 / 2	2 / 2	2 / 2
	LEDTS	3	3	-	-	-	-	-	-	-	-	3	3	3
	MultiCAN+ (nodes / MOs)	-	-	-	-	-	-	-	2 / 32	2 / 32	2 / 32	2 / 32	2 / 32	2 / 32

1.3 Device Types

These device types are available and can be ordered through Infineon's direct and/or distribution channels.

Table 2 Synopsis of XMC1400 Device Types

Derivative	Package	Flash Kbytes
XMC1401-Q048F0064	PG-VQFN-48	64
XMC1401-Q048F0128	PG-VQFN-48	128
XMC1401-F064F0064	PG-LQFP-64	64
XMC1401-F064F0128	PG-LQFP-64	128
XMC1402-T038X0032	PG-TSSOP-38	32
XMC1402-T038X0064	PG-TSSOP-38	64
XMC1402-T038X0128	PG-TSSOP-38	128
XMC1402-T038X0200	PG-TSSOP-38	200
XMC1402-Q040X0032	PG-VQFN-40	32
XMC1402-Q040X0064	PG-VQFN-40	64
XMC1402-Q040X0128	PG-VQFN-40	128
XMC1402-Q040X0200	PG-VQFN-40	200
XMC1402-Q048X0032	PG-VQFN-48	32
XMC1402-Q048X0064	PG-VQFN-48	64
XMC1402-Q048X0128	PG-VQFN-48	128
XMC1402-Q048X0200	PG-VQFN-48	200
XMC1402-Q064X0064	PG-VQFN-64	64
XMC1402-Q064X0128	PG-VQFN-64	128
XMC1402-Q064X0200	PG-VQFN-64	200
XMC1402-F064X0064	PG-LQFP-64	64
XMC1402-F064X0128	PG-LQFP-64	128
XMC1402-F064X0200	PG-LQFP-64	200
XMC1403-Q040X0064	PG-VQFN-40	64
XMC1403-Q040X0128	PG-VQFN-40	128
XMC1403-Q040X0200	PG-VQFN-40	200
XMC1403-Q048X0064	PG-VQFN-48	64
XMC1403-Q048X0128	PG-VQFN-48	128

2 General Device Information

This section summarizes the logic symbols and package pin configurations with a detailed list of the functional I/O mapping.

2.1 Logic Symbols

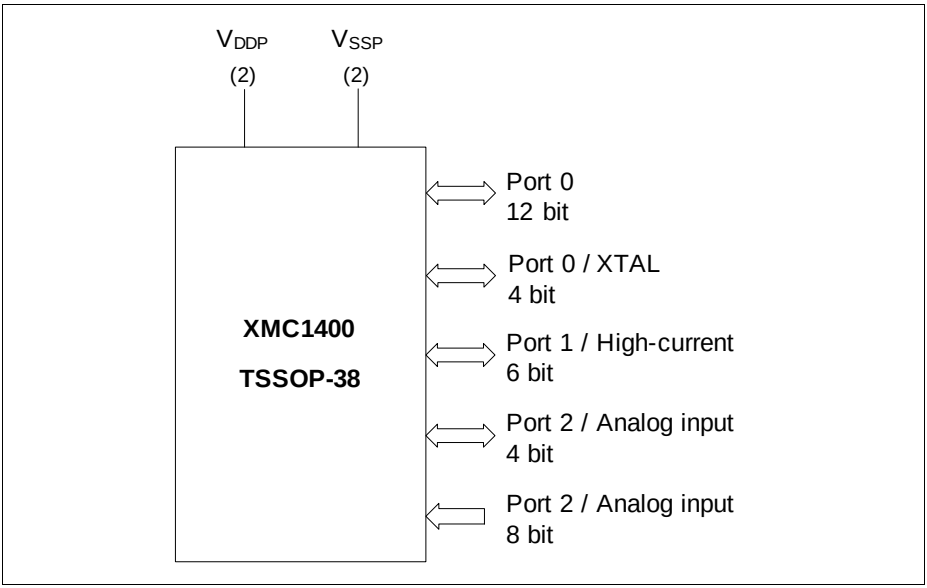

Figure 2 XMC1400 Logic Symbol for TSSOP-38-9

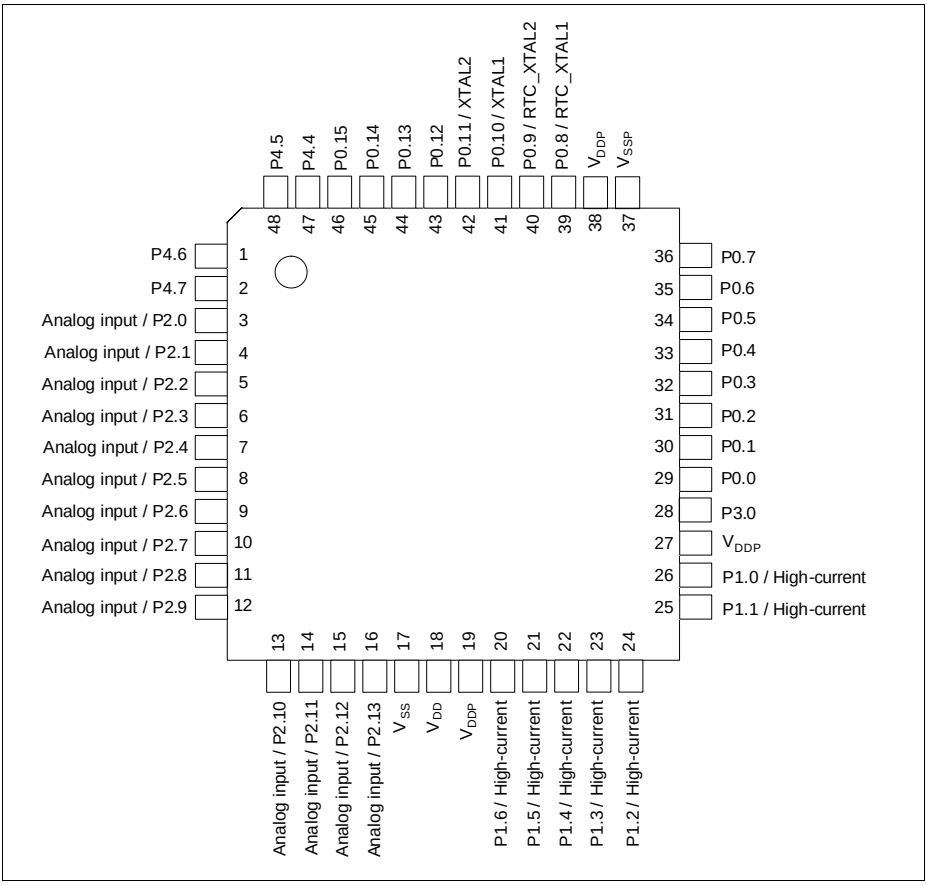

Figure 8 XMC1400 PG-VQFN-48-73 Pin Configuration (top view)

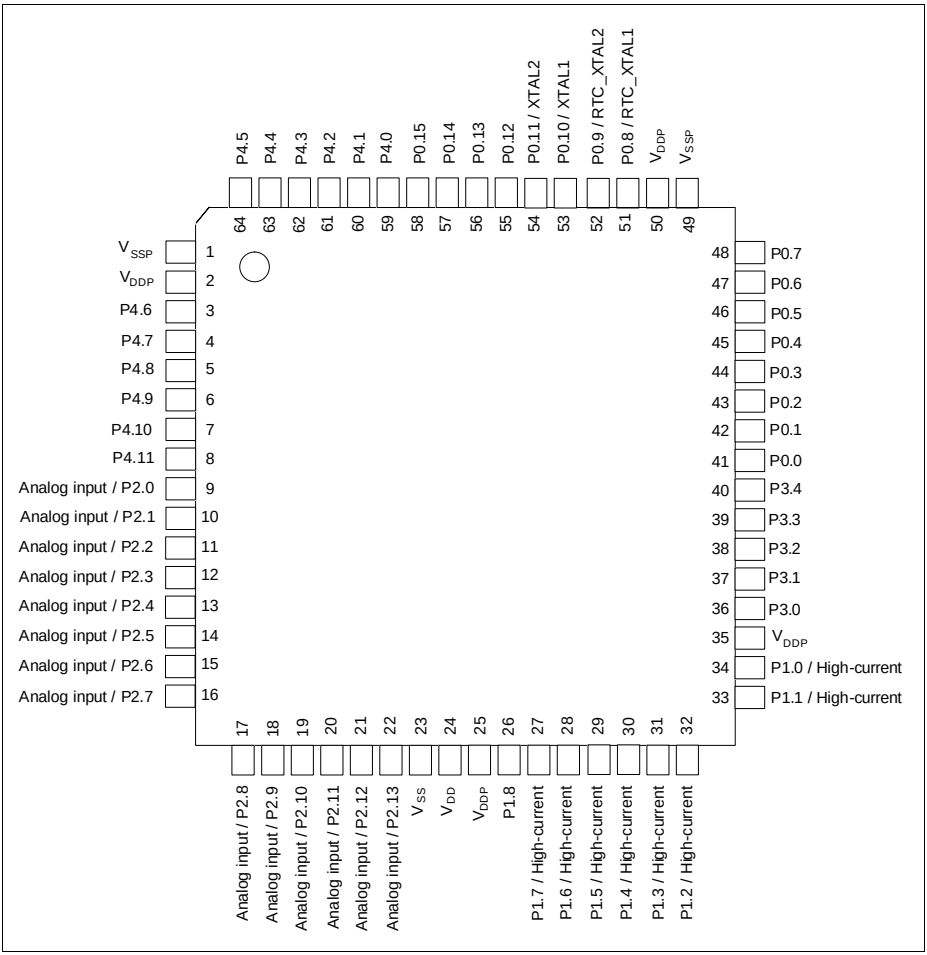

Figure 9 XMC1400 PG-LQFP-64-26 / PG-VQFN-64-6 Pin Configuration (top view)

2.2.2 Port Pin for Boot Modes

Port functions can be overruled by the boot mode selected. The type of boot mode is selected via BMI. **Table 6** shows the port pins used for the various boot modes.

Table 6 Port Pin for Boot Modes

Pin	Boot	Boot Description
P0.13	CS(O)	SSC BSL mode
P0.14	SWDIO_0	Debug mode (SWD)
	SPD_0	Debug mode (SPD)
	RX/TX	ASC BSL half-duplex mode
	RX	ASC BSL full-duplex mode
	RX	CAN BSL mode
	SCLK(O)	SSC BSL mode
P0.15	SWDCLK_0	Debug mode (SWD)
	TX	ASC BSL full-duplex mode
	TX	CAN BSL mode
	DATA(I/O)	SSC BSL mode
P1.2	SWDCLK_1	Debug mode (SWD)
	TX	ASC BSL full-duplex mode
	TX	CAN BSL mode
P1.3	SWDIO_1	Debug mode (SWD)
	SPD_1	Debug mode (SPD)
	RX/TX	ASC BSL half-duplex mode
	RX	ASC BSL full-duplex mode
	RX	CAN BSL mode
P4.6	HWCON0	Boot Pins (Boot from pins mode must be selected)
P4.7	HWCON1	

2.2.3 Port I/O Function Description

The following general building block is used to describe the I/O functions of each PORT pin:

Table 7 Port I/O Function Description

Function	Outputs		Inputs	
	ALT1	ALTn	Input	Input
P0.0		MODA.OUT	MODC.INA	
Pn.y	MODA.OUT		MODA.INA	MODC.INB

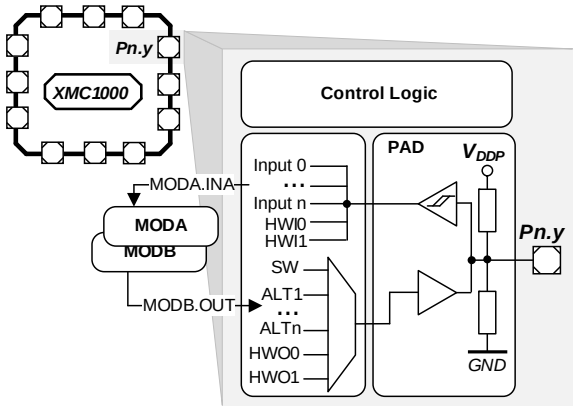

Figure 10 Simplified Port Structure

Pn.y is the port pin name, defining the control and data bits/registers associated with it. As GPIO, the port is under software control. Its input value is read via Pn_IN.y, Pn_OUT defines the output value.

Up to nine alternate output functions (ALT1 to ALT9) can be mapped to a single port pin, selected by Pn_IOCR.PC. The output value is directly driven by the respective module, with the pin characteristics controlled by the port registers (within the limits of the connected pad).

The port pin input can be connected to multiple peripherals. Most peripherals have an input multiplexer to select between different possible input sources.

The input path is also active while the pin is configured as output. This allows to feedback an output to on-chip resources without wasting an additional external pin.

Please refer to the **Port I/O Functions** table for the complete Port I/O function mapping.

Port I/O Function Table

Table 9 Port I/O Functions

Function	Outputs									Inputs											
	ALT1	ALT2	ALT3	ALT4	ALT5	ALT6	ALT7	ALT8	ALT9	Input	Input	Input	Input	Input	Input	Input	Input	Input	Input	Input	Input
P0.0	ERU0.PDOUT0	LEDTS0.LINE7	ERU0.GOUT0	CCU40.OUT0	CCU80.OUT00	USIC0_CH0.SELO0	USIC0_CH1.SELO0	CCU81.OUT00	USIC1_CH1.DOUT0	BCCU0.TRAPINB	CCU40.IN0AC					USIC1_CH1.DX0A	USIC0_CH0.DX2A		USIC0_CH1.DX2A		
P0.1	ERU0.PDOUT1	LEDTS0.LINE6	ERU0.GOUT1	CCU40.OUT1	CCU80.OUT01	BCCU0.OUT8	SCU.VDROP	USIC1_CH1.SCLKOUT	USIC1_CH1.DOUT0		CCU40.IN1AC					USIC1_CH1.DX0B	USIC1_CH1.DX1A				
P0.2	ERU0.PDOUT2	LEDTS0.LINE5	ERU0.GOUT2	CCU40.OUT2	CCU80.OUT02	VADC0.EMUX02	CCU80.OUT10	USIC1_CH0.SCLKOUT	USIC1_CH0.DOUT0		CCU40.IN2AC					USIC1_CH0.DX0A	USIC1_CH0.DX1A				
P0.3	ERU0.PDOUT3	LEDTS0.LINE4	ERU0.GOUT3	CCU40.OUT3	CCU80.OUT03	VADC0.EMUX01	CCU80.OUT11	USIC1_CH1.SCLKOUT	USIC1_CH0.DOUT0		CCU40.IN3AC					USIC1_CH0.DX0B					
P0.4	BCCU0.OUT0	LEDTS0.LINE3	LEDTS0.COL3	CCU40.OUT1	CCU80.OUT13	VADC0.EMUX00	WWDT.SERVICE_OUT	USIC1_CH1.SELO0	CAN.N0_TXD			CCU41.IN0AB	CCU80.IN0AB							CAN.N0_RXDA	
P0.5	BCCU0.OUT1	LEDTS0.LINE2	LEDTS0.COL2	CCU40.OUT0	CCU80.OUT12	ACMP2.OUT	CCU80.OUT01	VADC0.EMUX10	CAN.N0_TXD			CCU41.IN1AB	CCU80.IN1AB							CAN.N0_RXDB	
P0.6	BCCU0.OUT2	LEDTS0.LINE1	LEDTS0.COL1	CCU40.OUT0	CCU80.OUT11	USIC0_CH1.MCLKOUT	USIC0_CH1.DOUT0	VADC0.EMUX11	CCU41.OUT0		CCU40.IN0AB	CCU41.IN2AB						USIC0_CH1.DX0C			
P0.7	BCCU0.OUT3	LEDTS0.LINE0	LEDTS0.COL0	CCU40.OUT1	CCU80.OUT10	USIC0_CH0.SCLKOUT	USIC0_CH1.DOUT0	VADC0.EMUX12	CCU41.OUT1		CCU40.IN1AB	CCU41.IN3AB					USIC0_CH0.DX1C	USIC0_CH1.DX0D	USIC0_CH1.DX1C		
P0.8/ RTC_XTAL1	BCCU0.OUT4	LEDTS1.LINE0	LEDTS0.COLA	CCU40.OUT2	CCU80.OUT20	USIC0_CH0.SCLKOUT	USIC0_CH1.SCLKOUT	CCU81.OUT20	CCU41.OUT2		CCU40.IN2AB						USIC0_CH0.DX1B		USIC0_CH1.DX1B		
P0.9/ RTC_XTAL2	BCCU0.OUT5	LEDTS1.LINE1	LEDTS0.COL6	CCU40.OUT3	CCU80.OUT21	USIC0_CH0.SELO0	USIC0_CH1.SELO0	CCU81.OUT21	CCU41.OUT3		CCU40.IN3AB						USIC0_CH0.DX2B		USIC0_CH1.DX2B		
P0.10/ XTAL1	BCCU0.OUT6	LEDTS1.LINE2	LEDTS0.COL5	ACMP0.OUT	CCU80.OUT22	USIC0_CH0.SELO1	USIC0_CH1.SELO1	CCU81.OUT22					CCU80.IN2AB	CCU81.IN2AB			USIC0_CH0.DX2C		USIC0_CH1.DX2C		
P0.11/ XTAL2	BCCU0.OUT7	LEDTS1.LINE3	LEDTS0.COL4	USIC0_CH0.MCLKOUT	CCU80.OUT23	USIC0_CH0.SELO2	USIC0_CH1.SELO2	CCU81.OUT23									USIC0_CH0.DX2D		USIC0_CH1.DX2D		
P0.12	BCCU0.OUT6	LEDTS1.LINE4	LEDTS0.COL3	LEDTS1.COL3	CCU80.OUT33	USIC0_CH0.SELO3	CCU80.OUT20		CAN.N1_TXD	BCCU0.TRAPINA	CCU40.IN0AA	CCU40.IN1AA	CCU40.IN2AA	CCU81.IN0AU	CCU40.IN3AA	CCU80.IN0AA	USIC0_CH0.DX2E	CCU80.IN1AA	CCU80.IN2AA	CAN.N1_RXDA	CCU80.IN3AA

Table 10 Hardware I/O Controlled Functions

Function	Outputs	Outputs	Inputs	Inputs	Pull Control	Pull Control	Pull Control	Pull Control
	HWO0	HWO1	HWI0	HWI1	HW0_PD	HW0_PU	HW1_PD	HW1_PU
P4.4	LEDTS2. EXTENDED0		LEDTS2.TSIN0	LEDTS2.TSIN0	Reserved for LEDTS Scheme A: pull-down disabled always	Reserved for LEDTS Scheme A: pull-down enabled always	Reserved for LEDTS Scheme B: pull-up enabled and pull-down disabled, and vice versa	
P4.5	LEDTS2. EXTENDED1		LEDTS2.TSIN1	LEDTS2.TSIN1				
P4.6	LEDTS2. EXTENDED2		LEDTS2.TSIN2	LEDTS2.TSIN2				
P4.7	LEDTS2. EXTENDED3		LEDTS2.TSIN3	LEDTS2.TSIN3				
P4.8	LEDTS2. EXTENDED4		LEDTS2.TSIN4	LEDTS2.TSIN4				
P4.9	LEDTS2. EXTENDED5		LEDTS2.TSIN5	LEDTS2.TSIN5				
P4.10	LEDTS2. EXTENDED6		LEDTS2.TSIN6	LEDTS2.TSIN6				
P4.11	LEDTS2. EXTENDED7		LEDTS2.TSIN7	LEDTS2.TSIN7				

3.2.5 Temperature Sensor Characteristics

Note: These parameters are not subject to production test, but verified by design and/or characterization.

Table 20 Temperature Sensor Characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Measurement time	t_M CC	–	–	10	ms	
Temperature sensor range	T_{SR} SR	-40	–	115	°C	
Sensor Accuracy[1)]	T_{TSAL} CC	-6	–	6	°C	T_J > 20°C
		-10	–	10	°C	0°C ≤ T_J ≤ 20°C
		–	-/+8	–	°C	T_J < 0°C
Start-up time	t_{TSST} SR	–	–	15	µs	

1) The temperature sensor accuracy is independent of the supply voltage.

3.2.6 Oscillator Pins

Note: It is strongly recommended to measure the oscillation allowance (negative resistance) in the final target system (layout) to determine the optimal parameters for the oscillator operation. Please refer to the limits specified by the crystal or ceramic resonator supplier.

Note: These parameters are not subject to production test, but verified by design and/or characterization.

The oscillator pins can be operated with an external crystal/resonator (see **Figure 15**) or in direct input mode (see **Figure 16**).

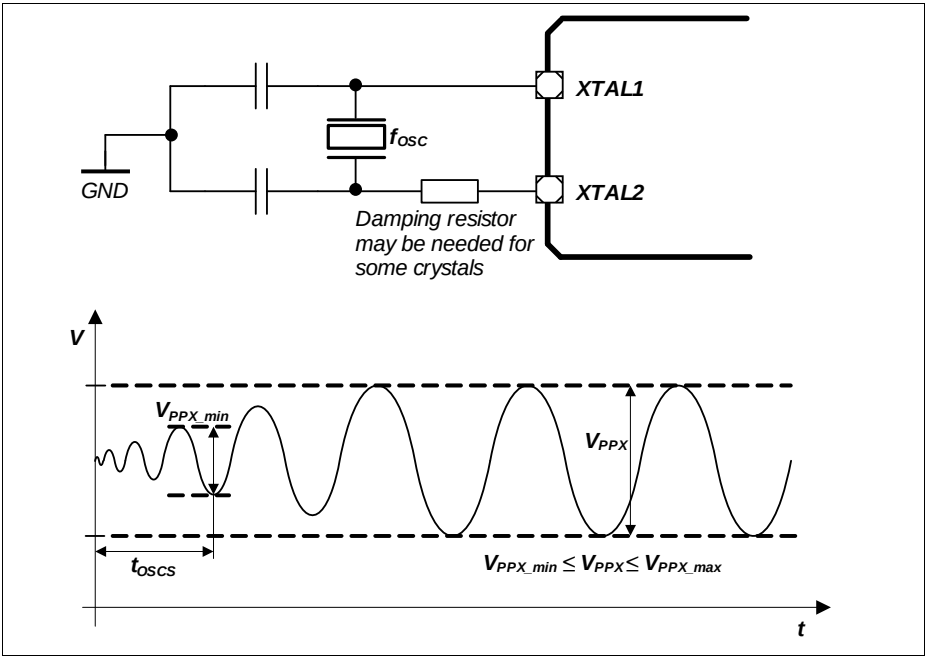

Figure 15 Oscillator in Crystal Mode

Table 22 RTC_XTAL Parameters

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Input frequency	f_{OSC} SR	–	32.768	–	kHz	
Oscillator start-up time[1)2)]	t_{OSCS} CC	–	–	5	s	
Input voltage at RTC_XTAL1	V_{IX} SR	-0.3	–	1.5	V	
Input amplitude (peak-to-peak) at RTC_XTAL1[2)3)]	V_{PPX} SR	0.2	–	1.2	V	

1) t_{OSCS} is defined from the moment the oscillator is enabled by the user with SCU_ANAOSCLPCTRL.MODE until the oscillations reach an amplitude at RTC_XTAL1 of 0.9 * V_{PPX}.

2) The external oscillator circuitry must be optimized by the customer and checked for negative resistance and amplitude as recommended and specified by crystal suppliers.

3) If the shaper unit is enabled and not bypassed.

3.2.7 Power Supply Current

The total power supply current defined below consists of a leakage and a switching component.

Application relevant values are typically lower than those given in the following tables, and depend on the customer's system operating conditions (e.g. thermal connection or used application configurations).

Note: These parameters are not subject to production test, but verified by design and/or characterization.

Table 23 Power Supply parameter table; V_{DDP} = 5V

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.[1]	Max.		
Active mode current Peripherals enabled f_{MCLK} / f_{PCLK} in MHz[2]	I_{DDPAE} CC	–	14.1	20	mA	48 / 96
		–	9.8	–	mA	24 / 48
		–	7.8	–	mA	16 / 32
		–	6.4	–	mA	8 / 16
		–	4.4	–	mA	1 / 1
Active mode current Peripherals disabled f_{MCLK} / f_{PCLK} in MHz[3]	I_{DDPAD} CC	–	6.2		mA	48 / 96
		–	4.6	–	mA	24 / 48
		–	3.6	–	mA	16 / 32
		–	3.1	–	mA	8 / 16
		–	1.8	–	mA	1 / 1
Active mode current Code execution from RAM Flash is powered down f_{MCLK} / f_{PCLK} in MHz	I_{DDPAR} CC	–	9.6	–	mA	48 / 96
Sleep mode current Peripherals clock enabled f_{MCLK} / f_{PCLK} in MHz[4]	I_{DDPSE} CC	–	11.0	–	mA	48 / 96
		–	7.6	–	mA	24 / 48
		–	6.4	–	mA	16 / 32
		–	5.3	–	mA	8 / 16
		–	4.2	–	mA	1 / 1

Table 24 provides the active current consumption of some modules operating at 5 V power supply at 25 °C. The typical values shown are used as a reference guide on the current consumption when these modules are enabled.

Table 24 Typical Active Current parameter table

Active Current Consumption	Symbol	Limit Values	Unit	Test Condition
		Typ.		
Baseload current	I_{CPUDDC}	4.14	mA	Modules including Core, SCU, PORT, memories, ANATOP[1)]
VADC and SHS	I_{ADCDDC}	3.73	mA	Set CGATCLR0.VADC to 1[2)]
USICx	$I_{USIC0DDC}$	1.35	mA	Set CGATCLR0.USIC0 to 1[3)]
CCU4x	$I_{CCU40DDC}$	0.99	mA	Set CGATCLR0.CCU40 to 1[4)]
CCU8x	$I_{CCU80DDC}$	1.00	mA	Set CGATCLR0.CCU80 to 1[5)]
POSIFx	$I_{PIF0DDC}$	1.05	mA	Set CGATCLR0.POSIF0 to 1[6)]
LEDTSx	$I_{LTSxDDC}$	1.14	mA	Set CGATCLR0.LEDTSx to 1[7)]
BCCU0	$I_{BCCU0DDC}$	0.29	mA	Set CGATCLR0.BCCU0 to 1[8)]
MATH	$I_{MATHDDC}$	0.50	mA	Set CGATCLR0.MATH to 1[9)]
WDT	I_{WDTDDC}	0.03	mA	Set CGATCLR0.WDT to 1[10)]
RTC	I_{RTCDDC}	0.01	mA	Set CGATCLR0.RTC to 1[11)]
MultiCAN	$I_{MCANDDC}$	1.38	mA	Set CGATCLR0.MCAN0 to 1[12)]

1) Baseload current is measured with device running in user mode, MCLK=PCLK=48 MHz, with an endless loop in the flash memory. The clock to the modules stated in CGATSTAT0 are gated.

2) Active current is measured with: module enabled, MCLK=48 MHz, running in auto-scan conversion mode

3) Active current is measured with: module enabled, each of the 2 USIC channels sending alternate messages at 57.6 kbaud every 200 ms

4) Active current is measured with: module enabled, MCLK=PCLK=48 MHz, 1 CCU4 slice for PWM switching at 20kHz with duty cycle varying at 10%-90%, 1 CCU4 slice in capture mode for reading period and duty cycle

5) Active current is measured with: module enabled, MCLK=PCLK=48 MHz, 3 CCU8 slices with PWM frequency at 20kHz and a period match interrupt used to toggle duty cycle between 10% and 90%

6) Active current is measured with: module enabled, MCLK=48 MHz, PCLK=96 MHz, hall sensor mode

7) Active current is measured with: module enabled, MCLK=48 MHz, 1 LED column, 6 LED/TS lines, Pad Scheme A with large pad hysteresis config, time slice duration = 1.048 ms

8) Active current is measured with: module enabled, MCLK=48 MHz, PCLK=96MHz, FCLK=0.8 MHz, Normal mode (BCCU clock = FCLK/4), 4 BCCU Channels with packers enabled and 1 Dimming Engine, change color or dim every 1s

9) Active current is measured with: module enabled, MCLK=48 MHz, PCLK=96 MHz, tangent calculation in while loop; CORDIC circular rotation, no keep, autostart; 32-by-32 bit signed DIV, autostart, DVS right shift by 11

3.3.2 Power-Up and Supply Threshold Characteristics

Table 26 provides the characteristics of the supply threshold in XMC1400.

The guard band between the lowest valid operating voltage and the brownout reset threshold provides a margin for noise immunity and hysteresis. The electrical parameters may be violated while V_{DDP} is outside its operating range.

The brownout detection triggers a reset within the defined range. The prewarning detection can be used to trigger an early warning and issue corrective and/or fail-safe actions in case of a critical supply voltage drop.

Note: These parameters are not subject to production test, but verified by design and/or characterization.

Table 26 Power-Up and Supply Threshold Parameters (Operating Conditions apply)

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
V_{DDP} ramp-up time	t_{RAMPUP} SR	V_{DDP}/ $S_{VDDPrise}$	–	10^7	µs	
V_{DDP} slew rate	S_{VDDPOP} SR	0	–	0.1	V/µs	Slope during normal operation
	S_{VDDP10} SR	0	–	10	V/µs	Slope during fast transient within +/-10% of V_{DDP}
	$S_{VDDPrise}$ SR	0	–	10	V/µs	Slope during power-on or restart after brownout event
	$S_{VDDPfall}$[1] SR	0	–	0.25	V/µs	Slope during supply falling out of the +/-10% limits[2]
V_{DDP} prewarning voltage	V_{DDPPW} CC	2.1	2.25	2.4	V	ANAVDEL.VDEL_SELECT = 00_B
		2.85	3	3.15	V	ANAVDEL.VDEL_SELECT = 01_B
		4.2	4.4	4.6	V	ANAVDEL.VDEL_SELECT = 10_B

3.3.6 Peripheral Timings

Note: These parameters are not subject to production test, but verified by design and/or characterization.

3.3.6.1 Synchronous Serial Interface (USIC SSC) Timing

The following parameters are applicable for a USIC channel operated in SSC mode.

Note: Operating Conditions apply.

Table 31 USIC SSC Master Mode Timing

Parameter	Symbol		Values			Unit	Note / Test Condition
			Min.	Typ.	Max.		
SCLKOUT master clock period	t_{CLK}	CC	$4/MCLK$	–	–	ns	
Slave select output SELO active to first SCLKOUT transmit edge	t_1	CC	$t_{CLK}/2$ - 28	–	–	ns	
Slave select output SELO inactive after last SCLKOUT receive edge	t_2	CC	0	–	–	ns	
Data output DOUT[3:0] valid time	t_3	CC	-28	–	28	ns	
Receive data input DX0/DX[5:3] setup time to SCLKOUT receive edge	t_4	SR	75	–	–	ns	
Data input DX0/DX[5:3] hold time from SCLKOUT receive edge	t_5	SR	0	–	–	ns	

Table 32 USIC SSC Slave Mode Timing

Parameter	Symbol		Values			Unit	Note / Test Condition
			Min.	Typ.	Max.		
DX1 slave clock period	t_{CLK}	SR	$4/MCLK$	–	–	ns	
Select input DX2 setup to first clock input DX1 transmit edge[1)]	t_{10}	SR	16	–	–	ns	

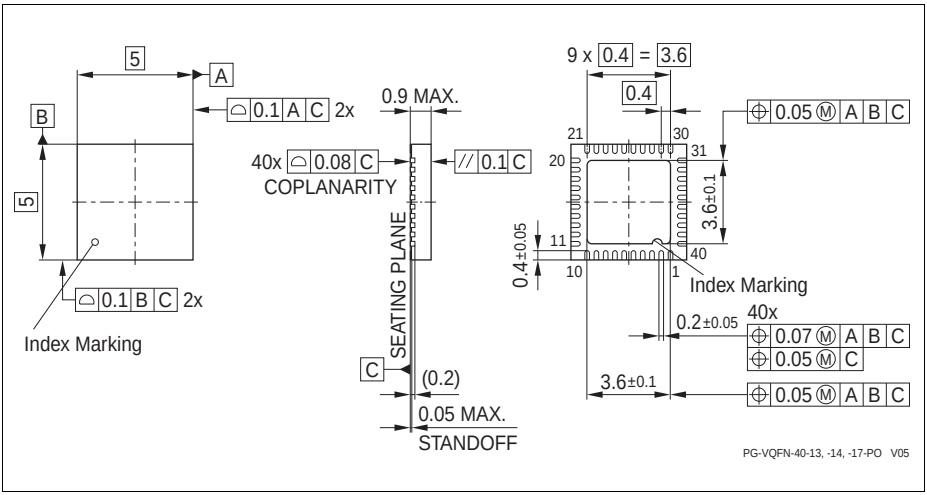

Figure 30 PG-VQFN-40-17

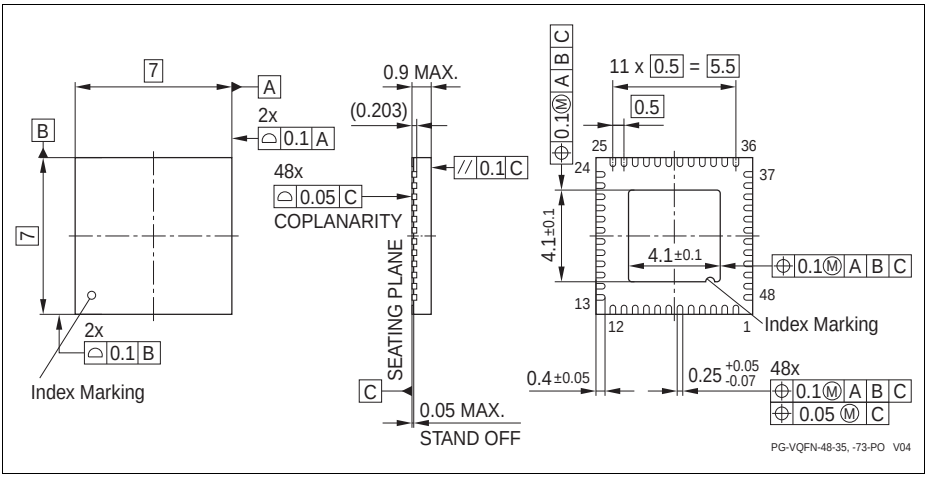

Figure 31 PG-VQFN-48-73